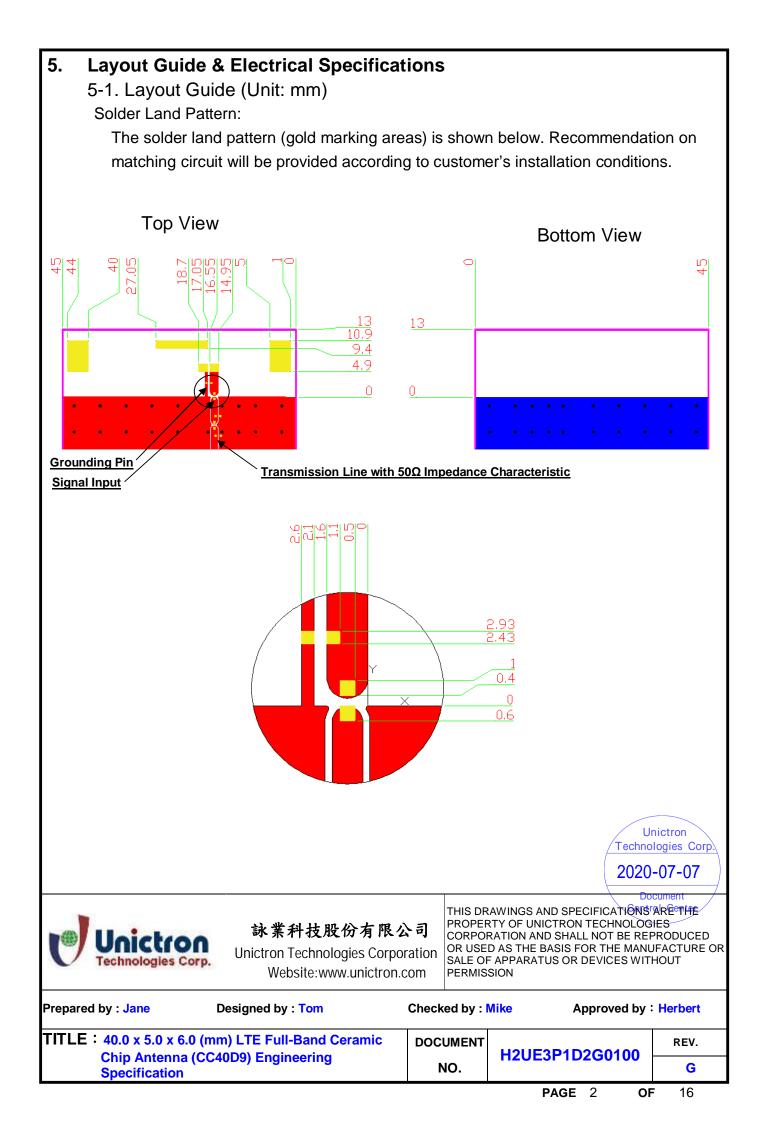
40.0 x 5.0 x 6.0 (mm) LTE Full-Band Ceramic Chip Antenna (CC40D9) **Engineering Specification** 1. **Product Number** 3 Р 2 Η 2 U Е 1 D G 0 1 0 0 Unistron 2. **Features** * Compatible with LTE full-band/ 3G/ 2G * Stable and reliable in performances * Compact size * RoHS2.0 compliance * SMT processes compatib * AEC-Q200 compliant 3. Applications * LTE full-band/ 3G/ 2G. * LTE / GSM / CDMA /DCS /PCS / WCDMA / UMTS / HSDPA / GPRS / EDGE /IMT. 4. Description Unictron's CC40D9 ceramic chip antenna is designed for cellular 2G/3G/LTE bands applications, covering frequencies 698~960 MHz & 1710~2690 MHz. Fabricated with proprietary design and processes, CC40D9 shows excellent performance and is fully compatible with SMT processes which can decrease the assembly cost and improve device's quality and consistency. Unictron Technologies Corp. 2020-07-07 THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES 詠業科技股份有限公司 CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR Unictron Technologies Corporation SALE OF APPARATUS OR DEVICES WITHOUT Technologies Corp. Website:www.unictron.com PERMISSION Prepared by : Jane Designed by : Tom Checked by : Mike Approved by : Herbert TITLE: 40.0 x 5.0 x 6.0 (mm) LTE Full-Band Ceramic DOCUMENT REV. H2UE3P1D2G0100 Chip Antenna (CC40D9) Engineering NO. G **Specification**

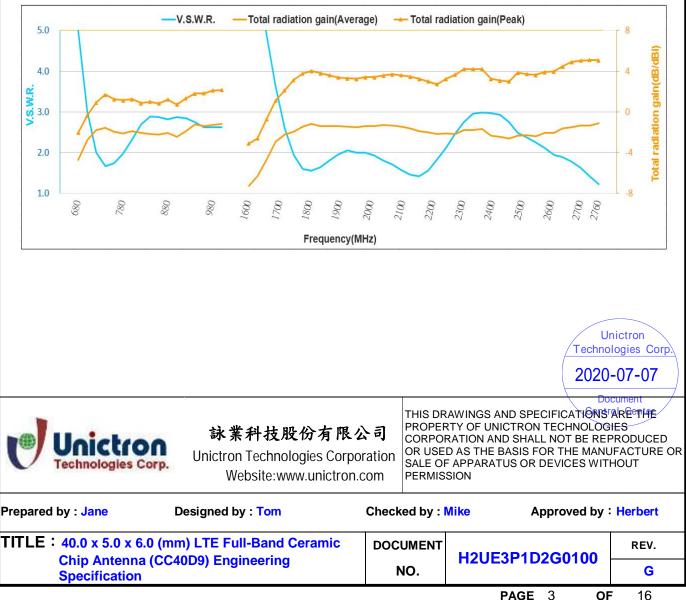


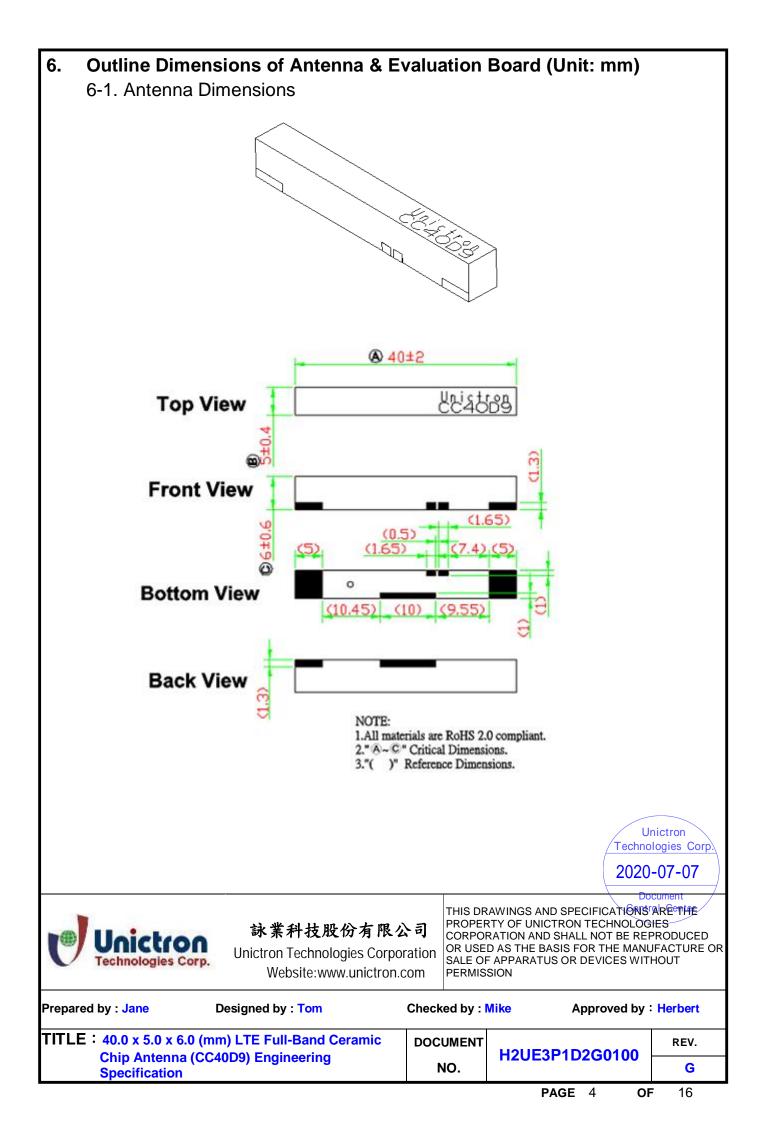
5-2. Electrical Specifications (with 120 x 45 mm² Evaluation Board) 5-2-1. Electrical Table **Characteristics Specifications** Outline Dimension (mm) 40.0 x 5.0 x 6.0 Ground Plane Dimension (mm) 107 x 45 Working Frequency (MHz) 824 ~ 960 1710 ~ 2170 2300 ~ 2400 2490 ~ 2690 698 ~ 798 Peak Gain (dBi) (typical)** 1.4 0.7 3.2 3.8 4.2

Efficiency (%) (typical)**	65	57	69	67	62	
VSWR (@ center frequency)*	<3.5 : 1					
Characteristic Impedance (Ω)	50					
Polarization	Linear Polarization					

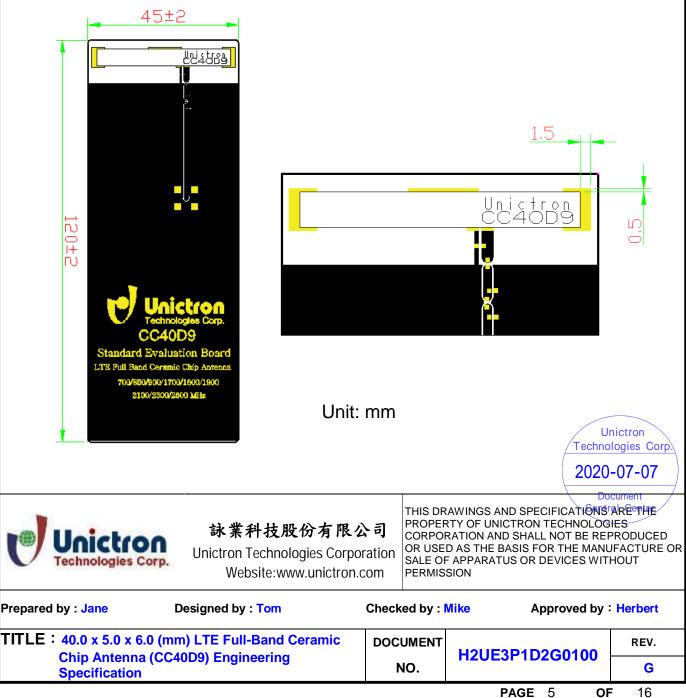
*Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board. **A typical value is for reference only, not guaranteed.

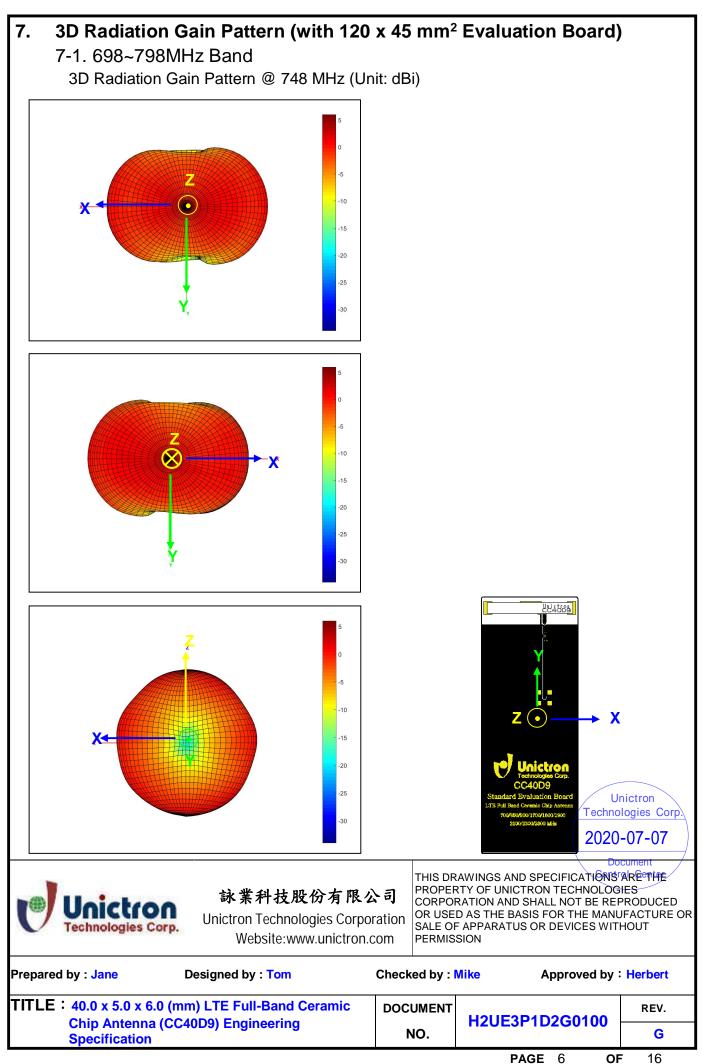
5-2-2. V.S.W.R. and Total Radiation Gain vs. Frequency

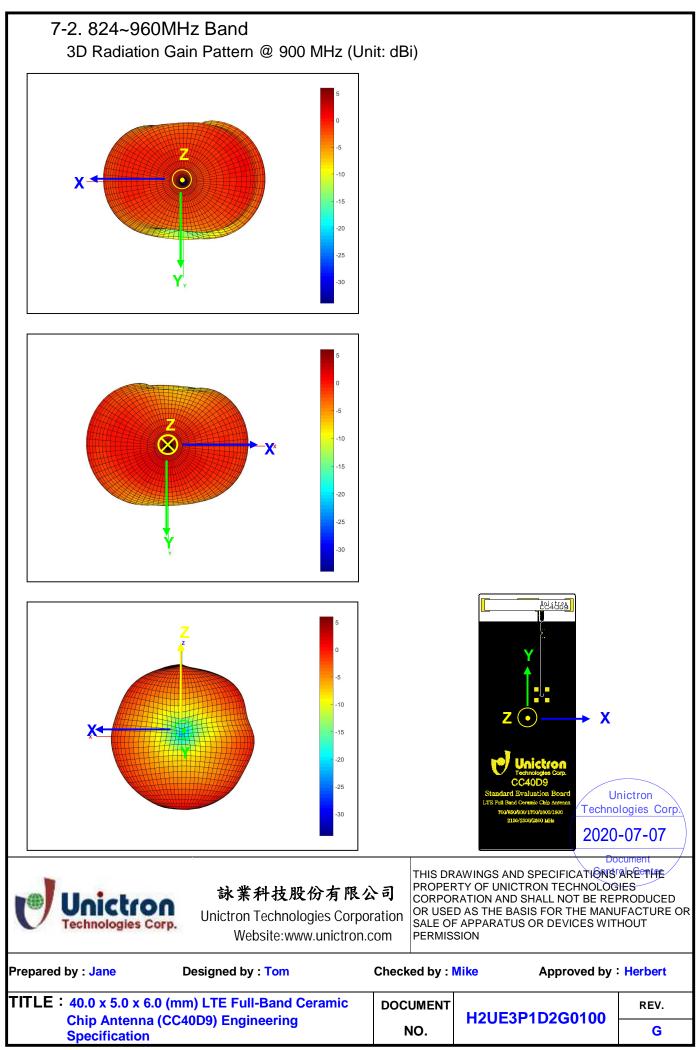


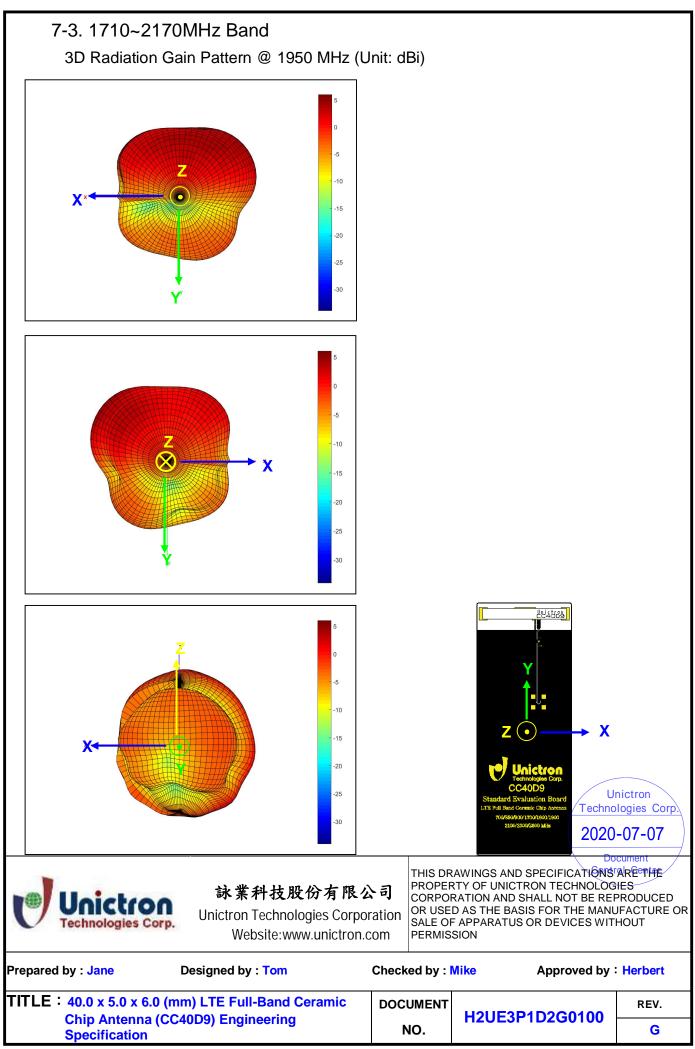


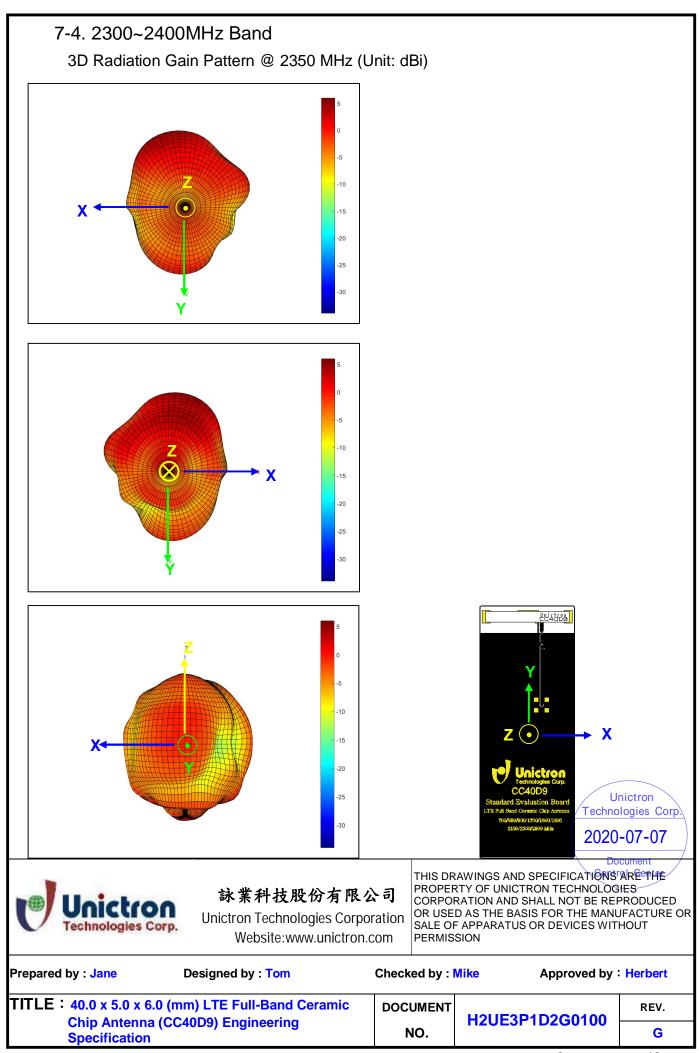
	PI	N1 PIN2	
PIN	3		PIN5
	PI	14	
	Botton	n View	
PIN	1	2	3~5
Soldering Pac	Tuning/Ground	Signal	N/C



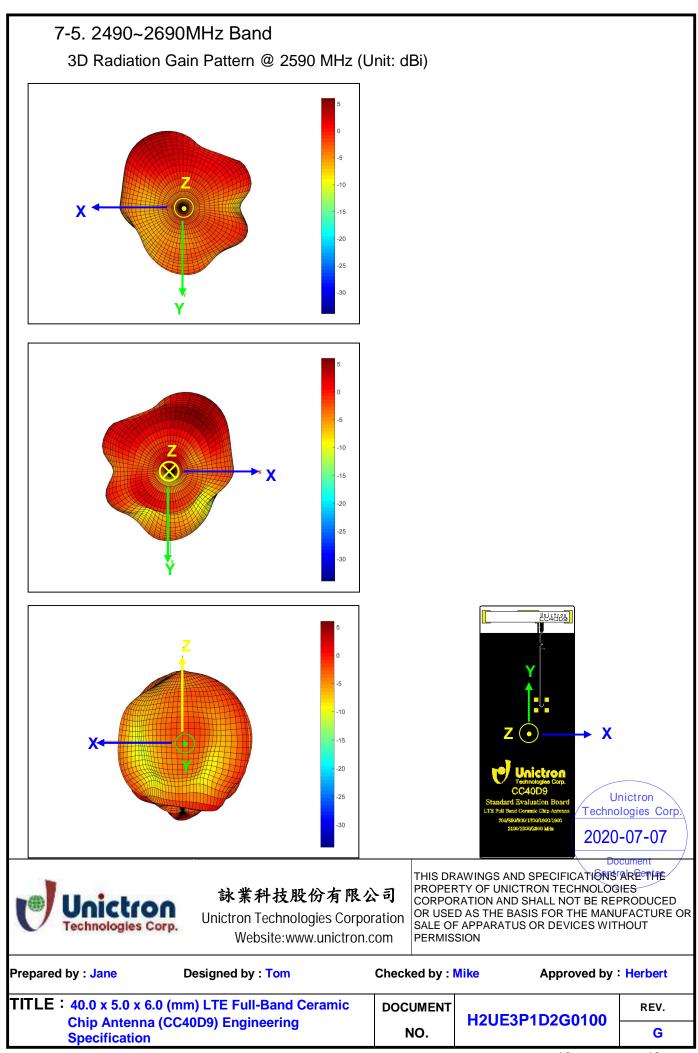






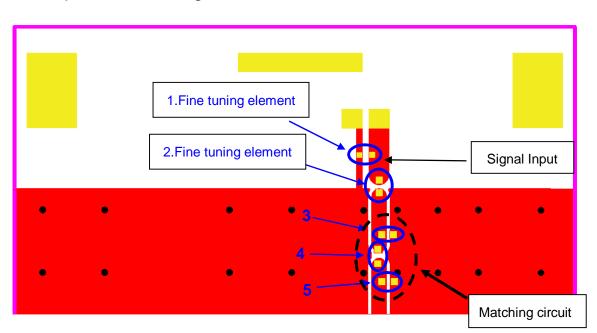


= 16



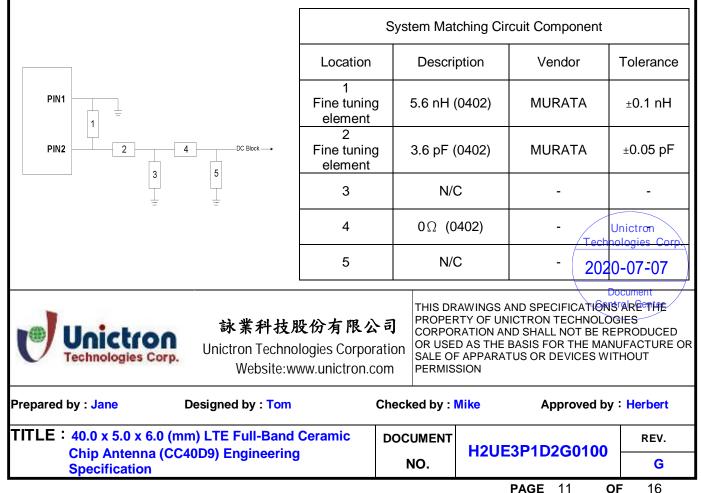
8. **Frequency tuning**

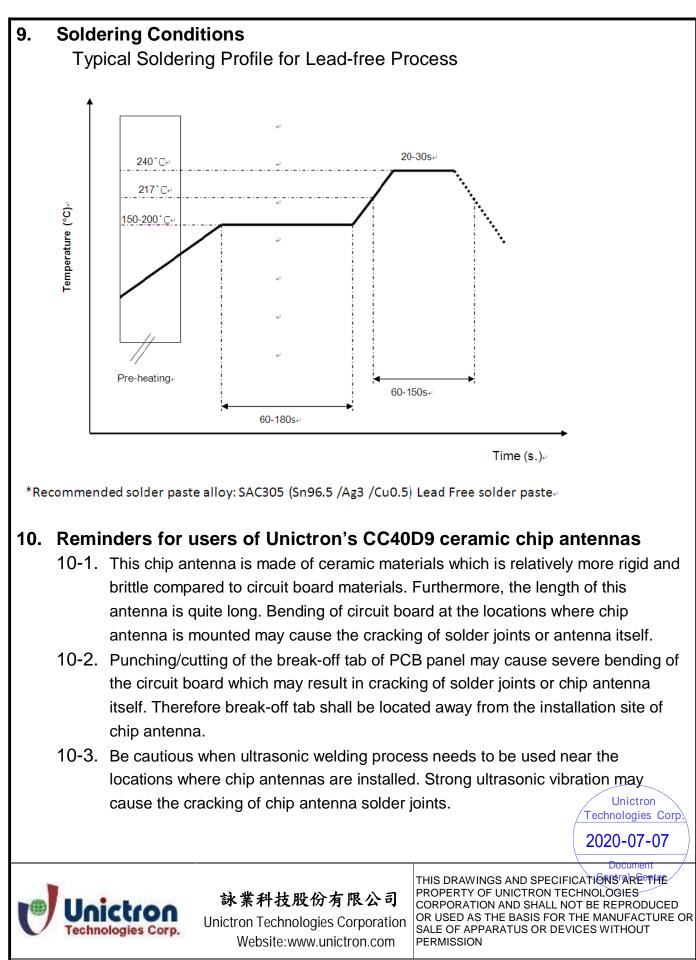
8-1. Chip antenna tuning scenario :



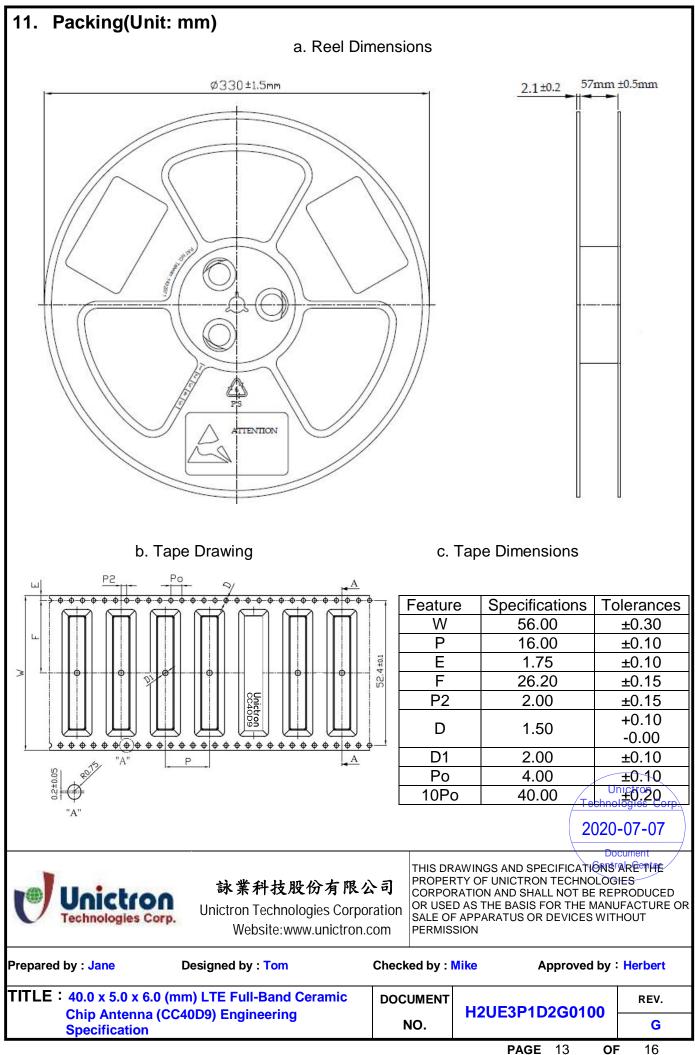
8-2. Matching circuit :

With the following recommended values of matching and tuning components, the covering frequencies will be about 698~960 MHz & 1710~2690 MHz at our standard 120 x 45 mm² evaluation board. However, these are typical reference values which may need to be changed when circuit boards or part vendors are different.





Prepared by : Jane	Designed by : Tom	Checked by : I	Mike Approved by	: Herbert
TITLE : 40.0 x 5.0 x 6.0 (mm) LTE Full-Band Ceramic		DOCUMENT	H2UE3P1D2G0100	REV.
Specification	a (CC40D9) Engineering	NO.	H20E3P1D200100	G
			PAGE 12 OI	= 16



d. (1) Weight: 1 pcs / 4.0g typ 1 Reel / 3.1Kg typ

- (2) Quantity/Reel: 600 pcs/Reel
- (3) Plastic tape: Clear Non Anti-static Polystyrene



- e. (1) Weight: 2 Reel /1 carton 6.8Kg typ
 - (2) 2 Reel / 1200 pcs in one carton
 - (3) Carton Dimensions 340*350*200 mm



12. Operating & Storage Conditions

- 12-1. Operating
 - (1) Maximum Input Power: 2 W
 - (2) Operating Temperature: -40 $^\circ\!\mathrm{C}$ to 85 $^\circ\!\mathrm{C}$
 - (3) Relative Humidity: 10% to 70%
- 12-2. Storage (sealed)
 - (1) Storage Temperature: -5 $^\circ\!\mathrm{C}$ to 40 $^\circ\!\mathrm{C}$
 - (2) Relative Humidity: 20% to 70%
 - (3) Shelf Life: 1 year

12-3. Storage (unsealed) Meet the criteria of <u>J-STD-033 MSL2a</u>

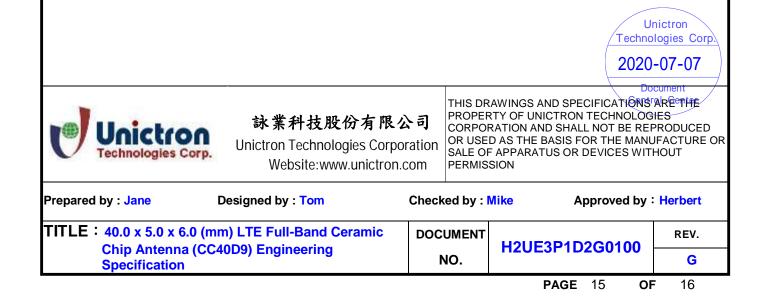
- 12-4. Storage (After mounted on customer's PCB with SMT process)
 - (1) Storage Temperature: -40 $^\circ\!\mathrm{C}$ to 85 $^\circ\!\mathrm{C}$
 - (2) Relative Humidity: 10% to 70%

13. Notice

(1) Installation Guide:

Please refer to Unictron's application note "General guidelines for the installation of Unictron's chip antennas" for further information.

(2) All specifications are subject to change without notice.



14. Reliability Test

Test Items	Test Condi	F	Result					
1. Solderability	*Solder Temperature : 25	$60 \pm 5^{\circ}C$						
	*Test time: 2 +/- 0.5 sec		Pass					
	*With solder paste							
2. Temperature cycling	-40°C/ 30min~90°C /30mi	n						
	Total <u>10</u> cycles							
	* Specimens are kept at s		Pass					
	measurement environment	n 24						
	hours before testing.							
3. Damp heat	*Humidity:90~95%							
	*Temperature: 85°C							
*Test time : 240 hours				Pass				
	* Specimens are kept at s		Pass					
	measurement environmer	n 24						
	hours before testing							
4. Adhesive strength of	* Resistance to bending o	f printed-circu	it					
terminal electrodes	test board(110x40x1.6mm		Dees					
	* Applied force: 5Kgf;			Pass				
	* Duration : 10±1sec							
5. High temperature exposure	*Temperature : 90°C			<u> </u>				
3	*Test duration : 240 hours		Pass					
	* Specimens are kept at s							
	measurement environmer		n 24					
	hours before testing.							
6. Low temperature exposure	*Temperature : -40°C							
	*Test duration : 240 hours	s		Pass				
	* Specimens are kept at s							
	measurement environmer	n 24						
	hours before testing.							
				Techno	nictron logies Corp. -07-07			
				Do	cument			
Si 業科技股份有限公司 Unictron Technologies Corporation Website:www.unictron.com Website:www.unictron.com Site Corporation Website:www.unictron.com Site Corporation Site Co			ARETHE IES PRODUCED IFACTURE OR					
Prepared by : Jane Desig	gned by : Tom	Checked by : I	Mike Appro	oved by :	Herbert			
TITLE : 40.0 x 5.0 x 6.0 (mm) LTE Full-Band Ceramic Chip Antenna (CC40D9) Engineering Specification		DOCUMENT		0400	REV.			
		NO.	NO. H2UE3P1D2G0100		C			
					G			